



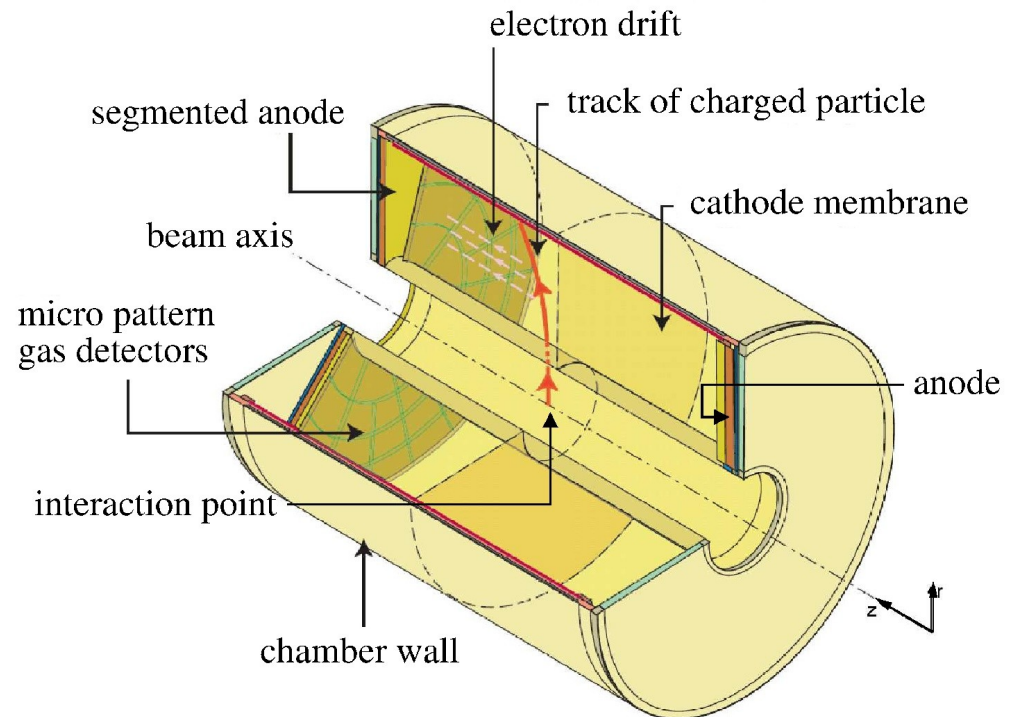
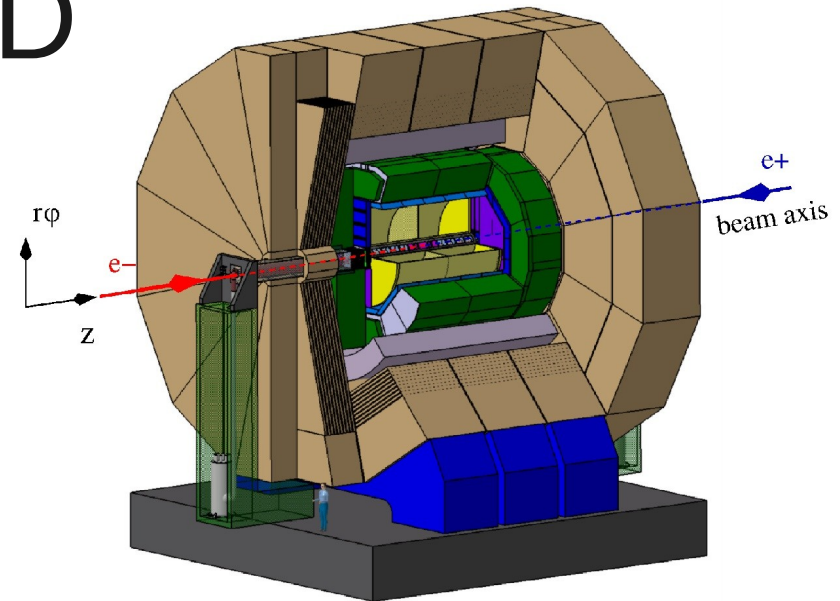
LCTPC status and progress

- Quick introduction to LCTPC
- Status of the readout technologies
 - Electron amplification
 - Electron readout
 - Readout electronics
- The Large Prototype (LP1->LP2)
- Simulation and reconstruction challenges
- Conclusion and outlook



TPC@ILD

- TPC as main tracker for ILD
 - Robust tracking, ~ 200 space points per track:
 - Easy pattern recognition
 - Robust towards machine backgrounds
 - dE/dx -measurement input to particle ID
 - $\sigma \leq 100\mu\text{m}$ ($r\phi$) @ 3.5 T and $\leq 500\mu\text{m}$ (rz)
 $\Rightarrow \Delta(1/p_T) < 10^{-4}/\text{GeV}/c$
 - Well suited for Particle Flow concept:
 - Good track separation
 - Good pattern recognition
 - Very lightweight
 barrel $< 5\%X_0$
 end plate $\sim 25\%X_0$





Challenges of LCTPC

- Field cage
- Endplate
- Amplification structure
- Readout structure
- Reconstruction
- Mechanical properties
Field quality
- Material budget
- Technology choice: MPGD
Electrical and mechanical stability
large area coverage ↔ dead space
Ion back-drift
- Pad or pixel based
Compactness and integration
Cooling, power pulsing
- Calibration and alignment
Correction of field inhomogeneities
Curled tracks

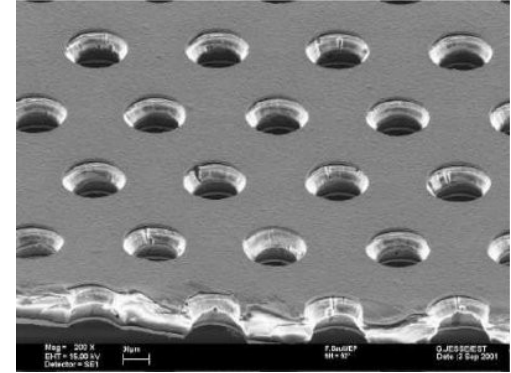


Technologies

- Electron Amplification with MPGDs
 - GEM
 - MicroMEGAS
- Electrons readout
 - Classic pad readout
 - Pixel detectors
- Readout electronics
 - Present: ALTRO, SALTRO, AFTER
 - Future: GdSP

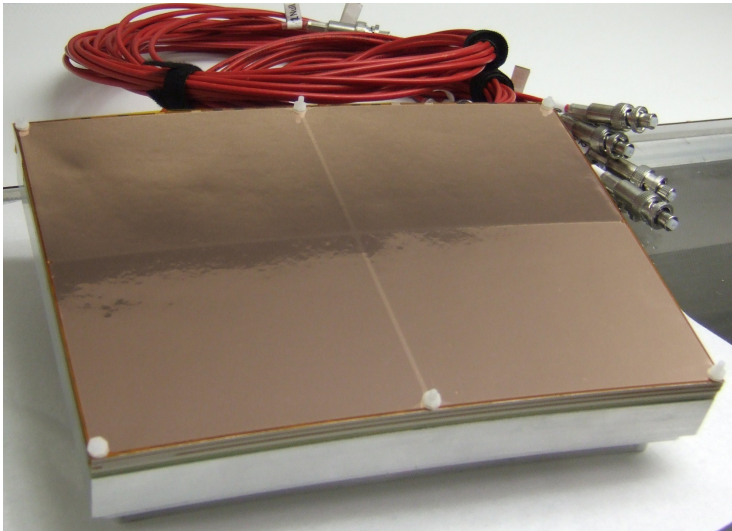


GEM



“DESY” Module

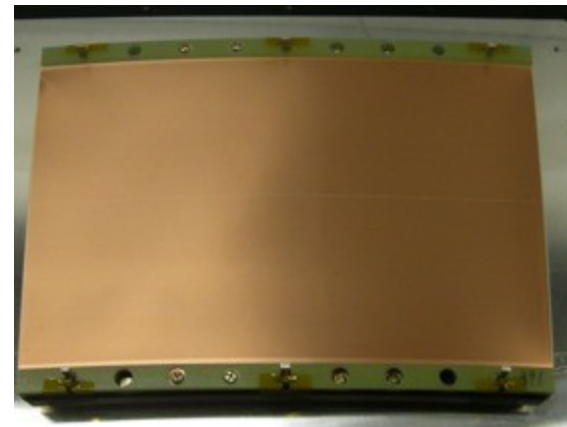
- “Thin” (50 μ m) GEM
- Triple GEM stack
- Ceramic support



- New module will be tested end of summer

“Asian” Module

- “Thick” (100 μ m) GEM
- Double GEM stack
- Stretching to minimise dead region in the phi direction

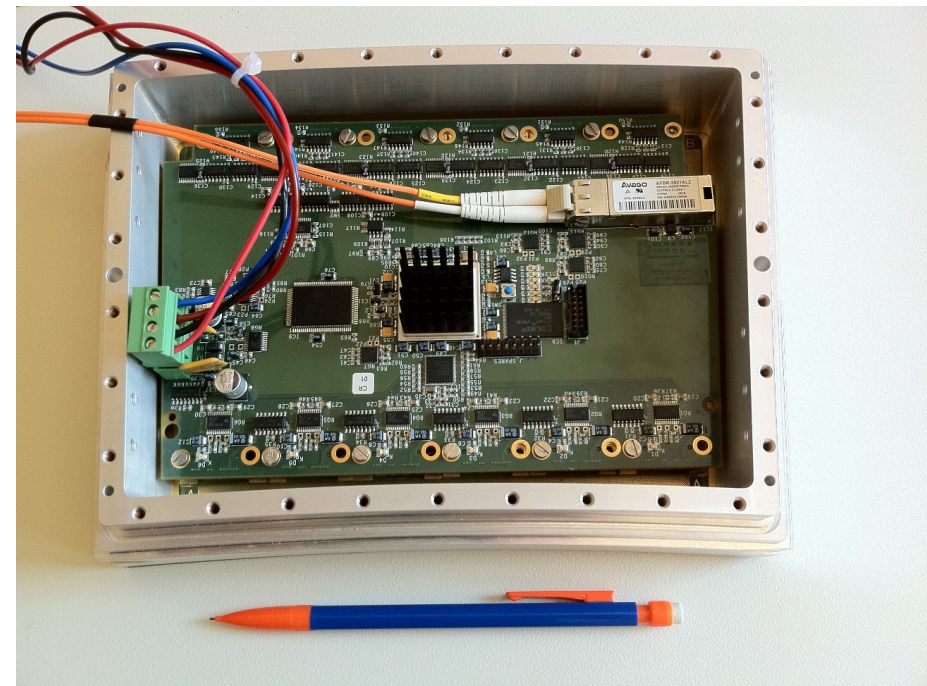
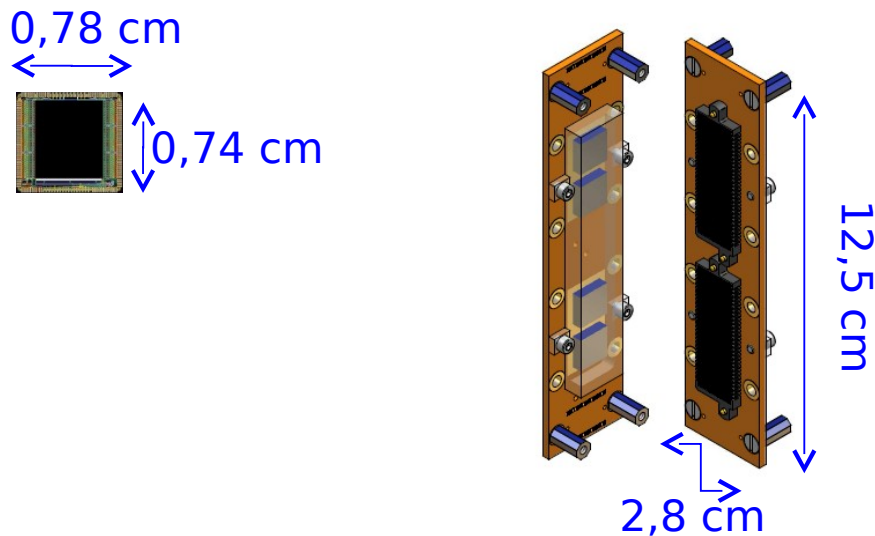
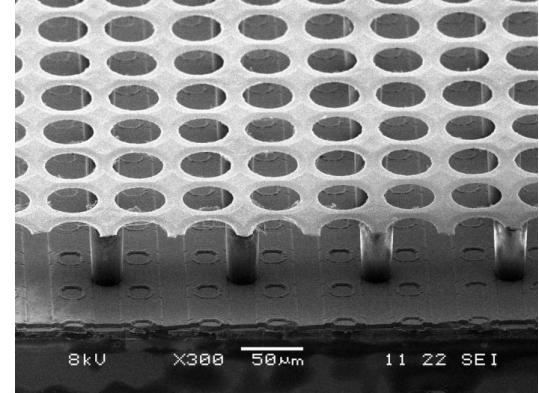


- New GEM (new processing)
- New readout electronics in 2013



Micromegas

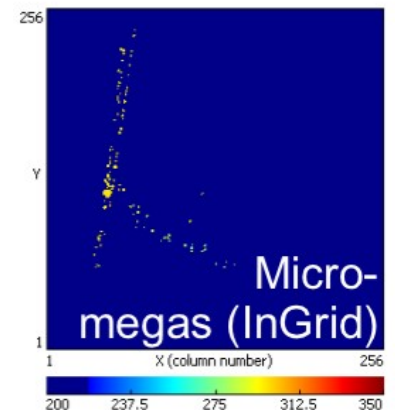
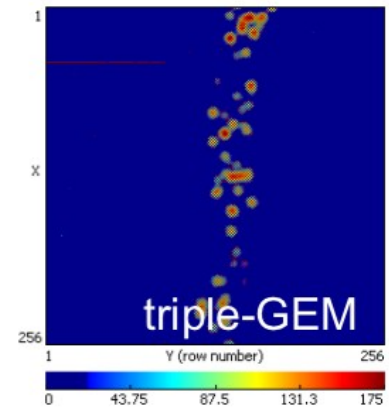
- Micromesh gas amplification
- New modules with integrated electronics (AFTER chips) in Saclay
- Should be tested in Large Prototype in DESY in July





Timepix

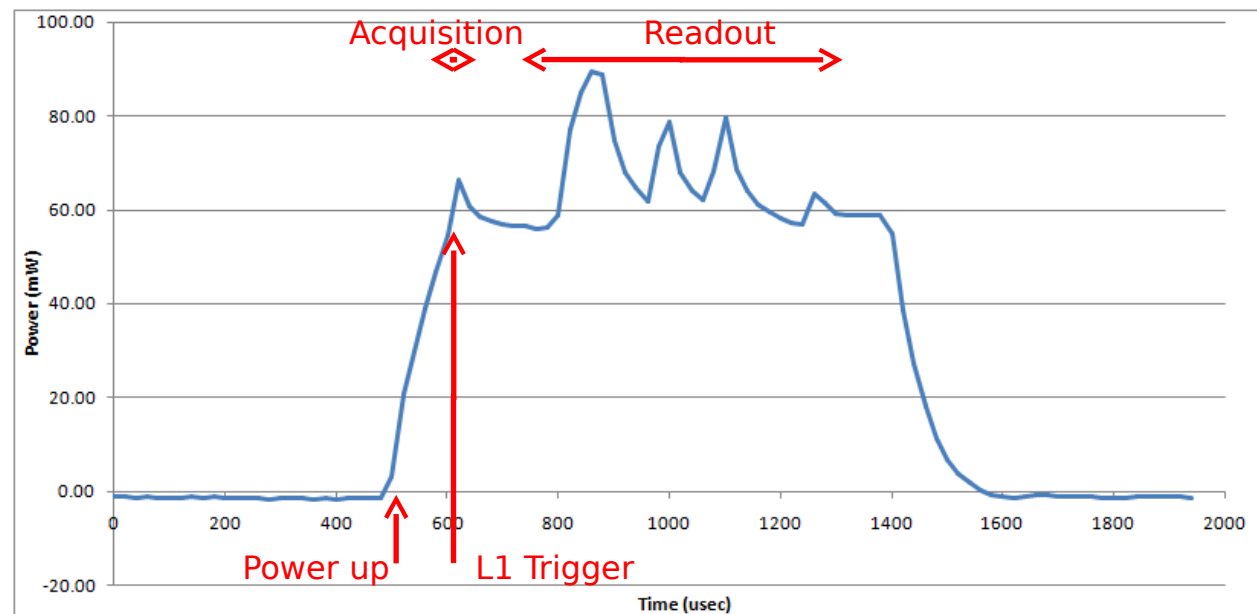
- Classic pad readout $\sim 1 \times 5 \text{ mm}^2 \Rightarrow$ Timepix chip readout $55 \times 55 \mu\text{m}^2$
- Resolution to distinguish single ionisation electrons
 \Rightarrow diffusion is the only limitation to momentum resolution
- Readout possible with different MPGDs (GEM or Micromegas)
- New process being studied for InGrid (Micromegas)
- Work started for a full module
(~ 120 Timepix chips ≈ 8 million pixels)





Readout electronics SALTRO16

- SALTRO16 tested successfully on electronics testbench
- Power pulsing demonstrated to reduce power consumption by a factor 60 with 5Hz repetition



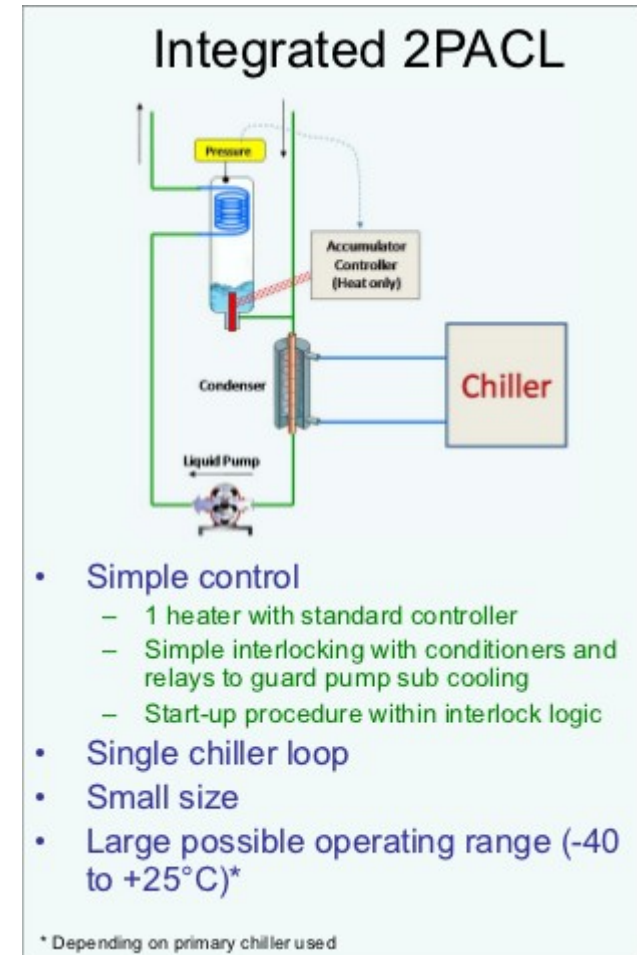
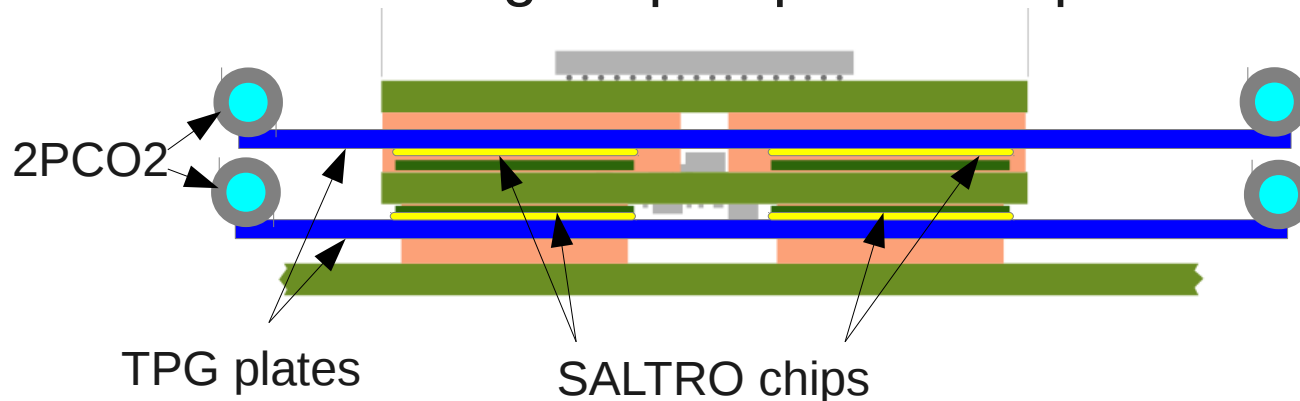
- SALTRO shows very good performance. Work has already started on GdSP, a final version for LCTPC



Electronics cooling

- 2-phase CO₂ cooling system
- Preliminary investigations to cool the SALTRO via plates of highly conductive material (TPG)

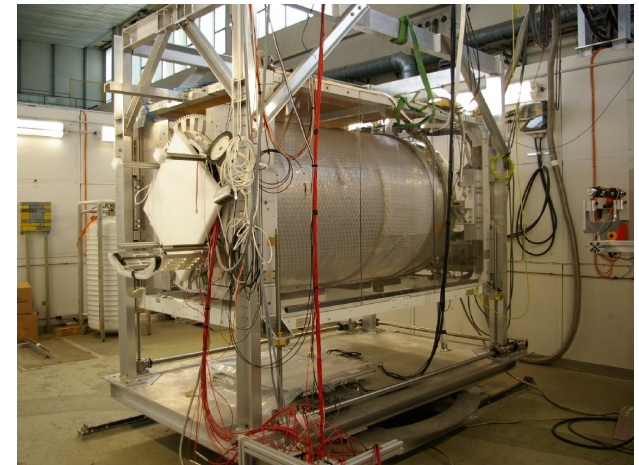
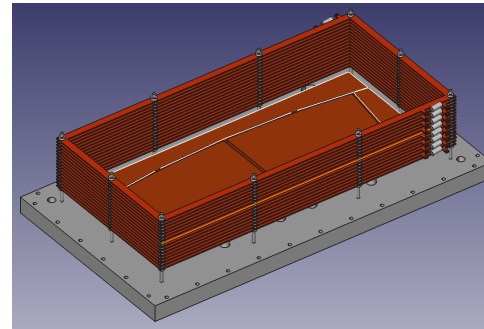
Necessary for LP test (no power pulsing)
Interesting for pad plane temperature





Test setups

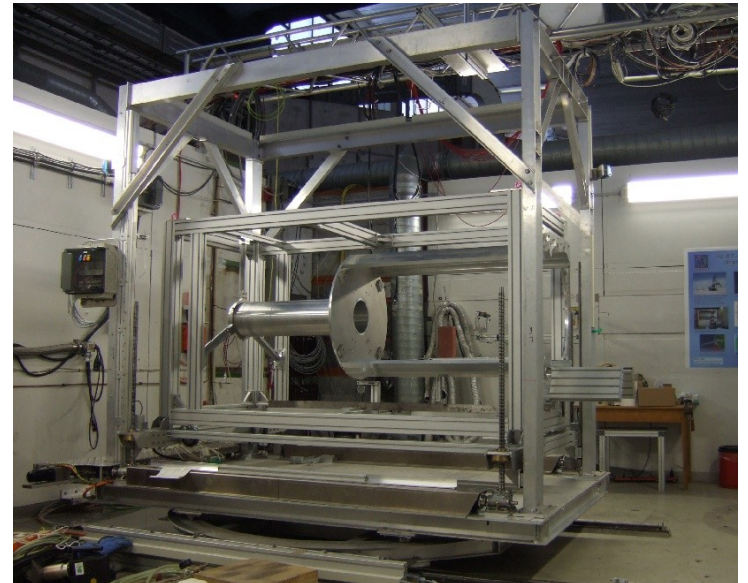
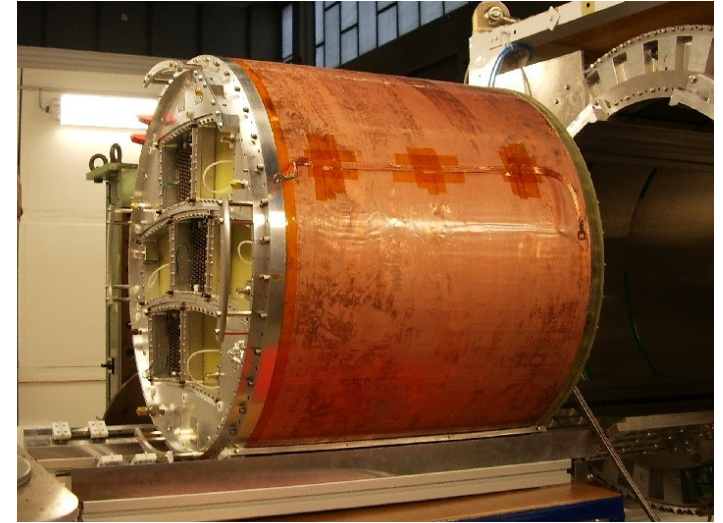
- Small prototypes
 - Proof of principle
 - Test of technical details
 - At local institutes
- Large Prototype
 - LP1
 - Upgrade to LP2
 - Test beam (e^- @DESY, hadron beam?)





LP1

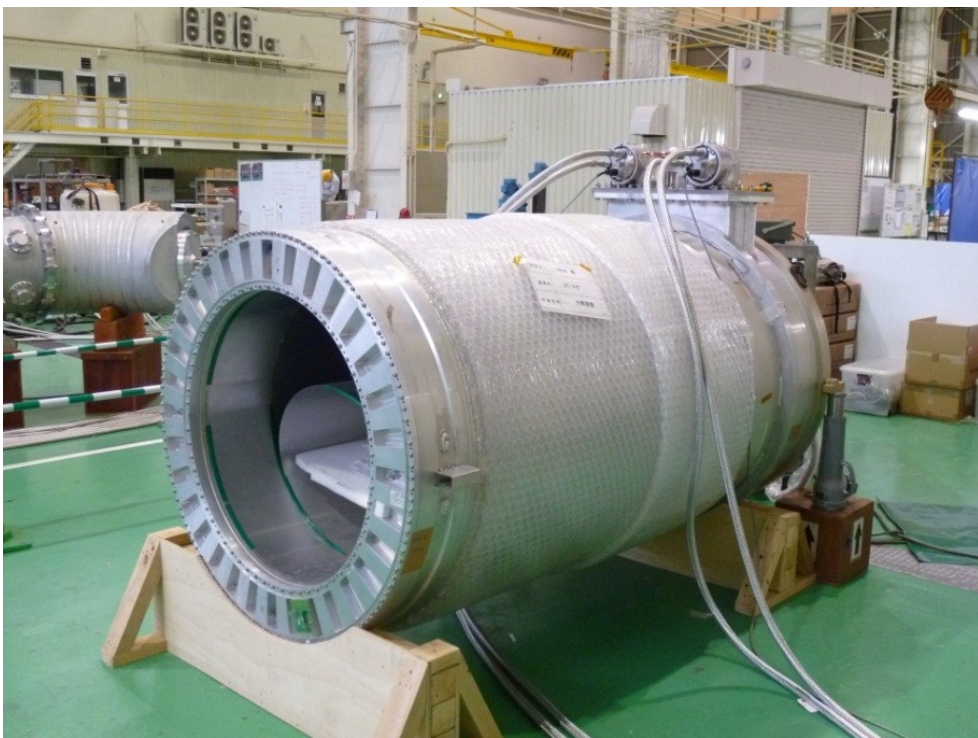
- Large Prototype 1
 - $\varnothing=72\text{cm}$, $L=61\text{cm}$
 - 1T magnetic field
 - 7 readout modules
- Test beam at DESY
 - 1-6 GeV electron beam
- Upgrades towards LP2
 - Upgraded PCMAG (in DESY, being installed)
 - New end plate (built, being tested)
 - New field cage (end 2012)





PCMAG

- PCMAG: 1T superconducting magnet
- Upgraded: Liquid Helium → Cryocoolers



Two-stage 4k cryo-cooler
To cool coil and the 1st -radiation shield

Sumitomo Cryogenics 4K cryo-cooler
RDK-408D2 with a compressor F-50:
1st Stage Capacity : 34W @40K @5 0Hz
2nd Stage Capacity 1.0W @4.2K @ 50Hz

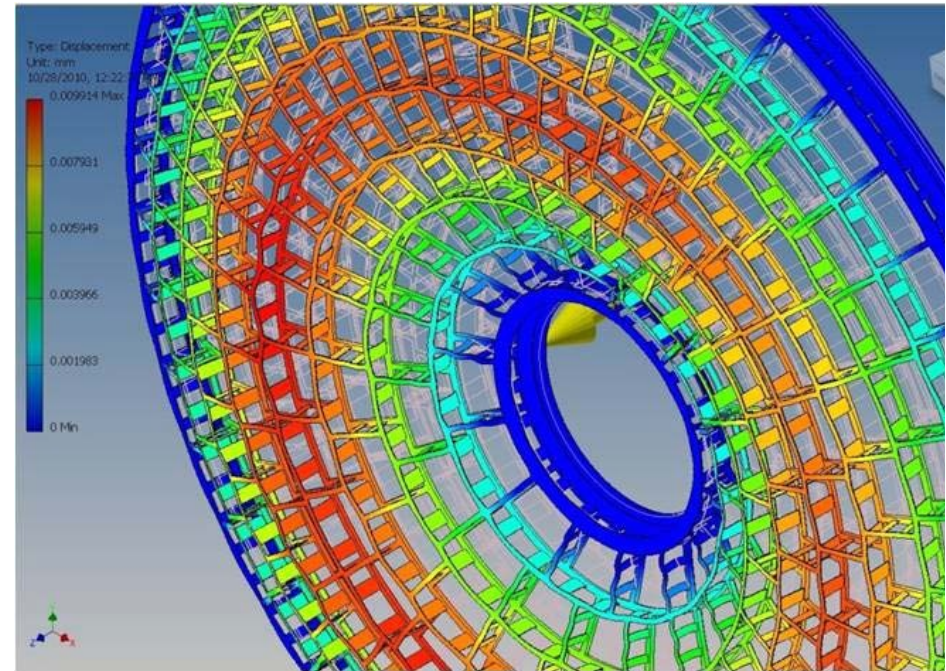
One stage 10K cryocooler
To cool HTc-superconductive current leads

Sumitomo Cryogenics 10K cryo-cooler
RDK-400B with a compressor F-50
1st Stage Capacity : 54W@40K @ 50Hz



End plates

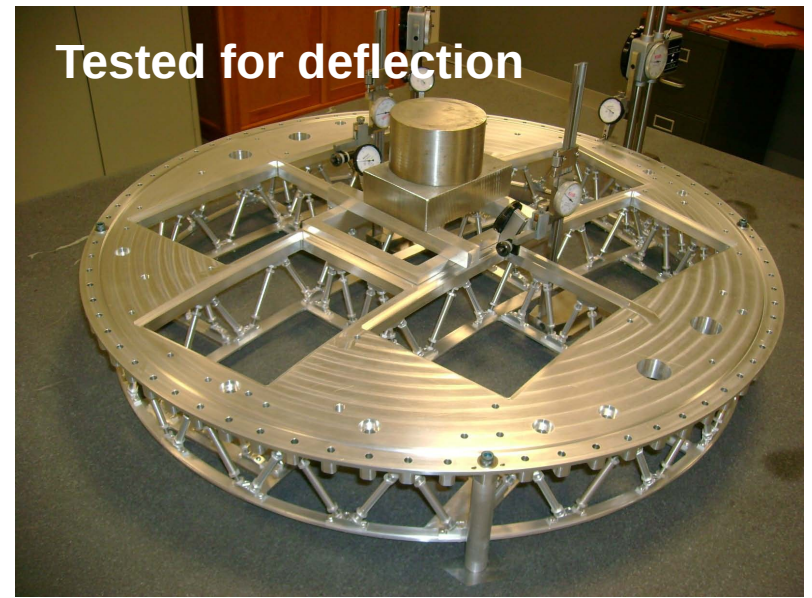
- LPTPC material budget ($25\% X_0$)
 - readout 5%
 - cooling 2%
 - power cables 10%
 - mechanical structure 8%
- Rigid
 - Precision of x,y positions $< 50\mu\text{m}$



New end plate for LP2



Tested for deflection





Data reconstruction and simulation

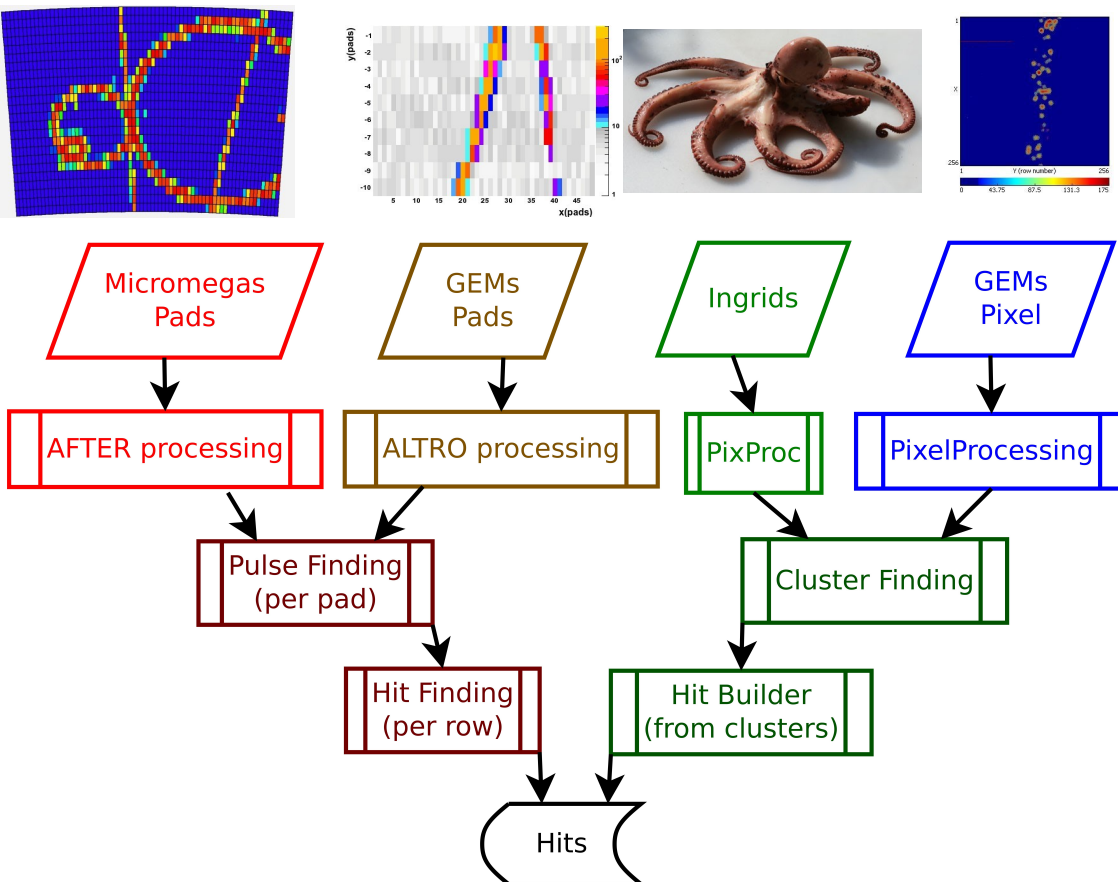
- Understanding the possible distortions
- Reconstruction and simulation framework



Software framework: MarlinTPC

- Reconstruction for all module types

- Continued improvement and debugging
- More and more functionalities integrated
- Ongoing work to improve calibration and alignment
- Extension of simulation capabilities

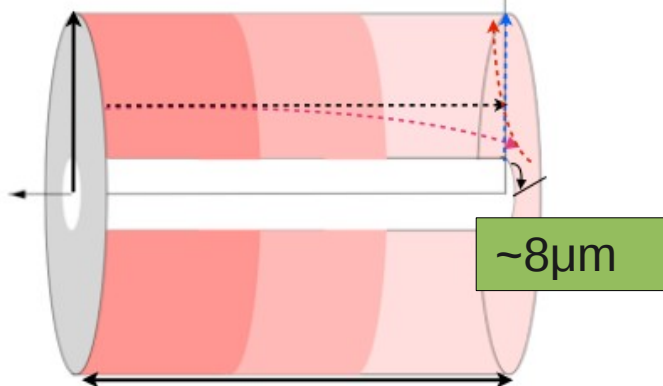




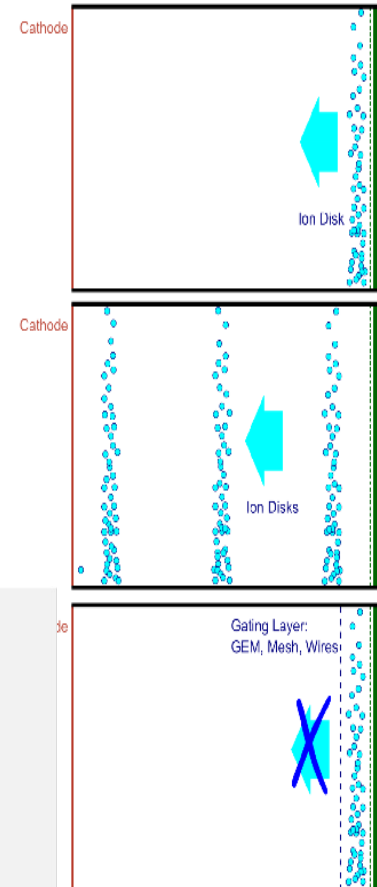
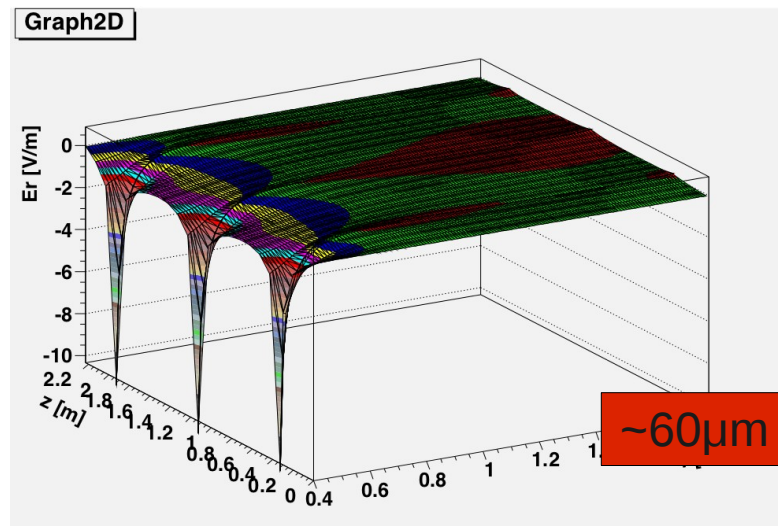
Ion back drift

- Simulation of positive ion effects
- Compare effect of:

primary ions created
by the tracks (3 trains)



ion disc created
by amplification



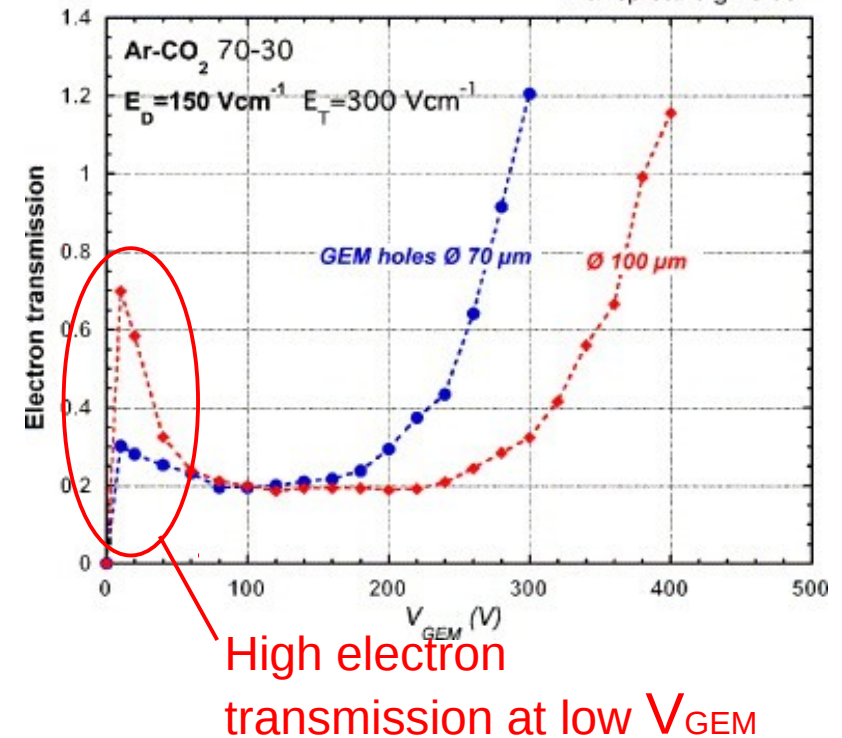
- Primary ions effect **small**
- MPGD ions effects **too large**
=> gate required



Gating system investigation

- GEM gating:
 - possibility shown by Sauli
- Need of thin GEM with wide aperture for good electron transmission
 - Technically difficult, work ongoing
- Wire gate considered as backup solution

F.Sauli, L.Ropelewski, P.Everaerts NIM A560 (2006) 269-277
Transp std-big holes





Conclusion and outlook

- All systems are progressing, modules going to realistic configurations
- Good space point resolution on single modules
- Upgraded test beam facility (PCMAG, LP2) to test momentum resolution
- Plans to go to hadron beam to test multitrack environment